Product Specification

QNN80N06AJ

60V N-Channel MOSFET

FEATURES

- 60V, 60A

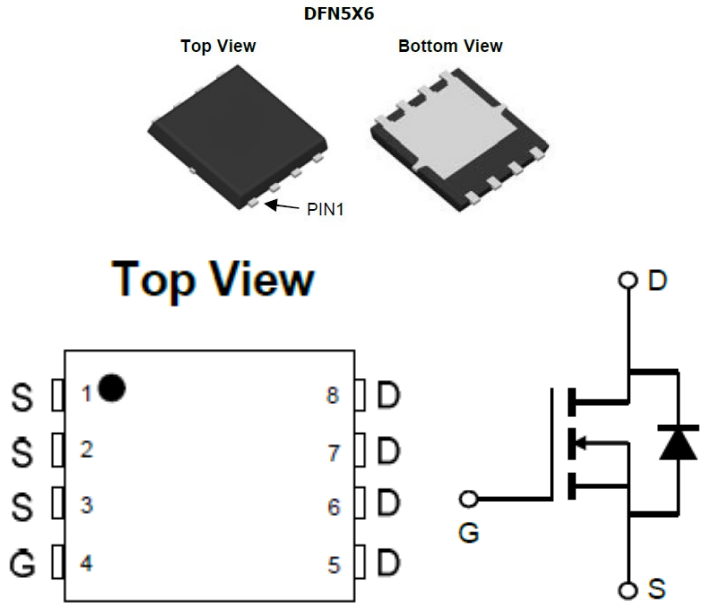
  $R_{DS(ON)}$ Typ = 8.4mΩ @ V_{GS} = 10V

  $R_{DS(ON)}$ Typ = 10.2mΩ @ V_{GS} = 4.5V
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free

Applications

- Load Switch
- PWM Application
- Power Management

Pin Description



NO.	Symbol	Description
1	S	SOURCE
2	S	SOURCE
3	S	SOURCE
4	G	GATE
5	D	DRAIN
6	D	DRAIN
7	D	DRAIN
8	D	DRAIN

Absolute Maximum Ratings

(@ T_C = 25℃ unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		60	V
V_{GS}	Gate-to-Source Voltage		±20	V
I_D	Continuous Drain Current	T_C = 25°C	60	A
		T_C = 100°C	36	
I_{DM}	Pulsed Drain Current (1)		Refer to Fig.4	A
E_{AS}	Single Pulsed Avalanche Energy (2)		102	mJ
P_D	Power Dissipation	T_C = 25°C	68	W
		T_C = 100°C	42	
T_J, T_{STG}	Junction & Storage Temperature Range		-55 to 150	℃

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient(3)	48	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.9	

Electrical Characteristics

(T_J = 25℃ unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 60V, V_{GS} = 0V	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	1.1	1.6	2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance(4)	V_{GS} = 10V, I_D = 20A	-	8.4	9.6	mΩ
		V_{GS} = 4.5V, I_D = 15A	-	10.2	13.8	mΩ
Dynamic Characteristics						
R_g	Gate Resistance	f = 1MHz	-	1.7	-	Ω
C_{iss}	Input Capacitance	V_{GS} = 0V, V_{DS} = 30V, f = 1MHz	-	4032	-	pF
C_{oss}	Output Capacitance		-	186	-	pF
C_{rss}	Reverse Transfer Capacitance		-	152	-	pF
Q_g	Total Gate Charge	V_{GS} = 0 to 10V, V_{DS} = 30V, I_D = 30A	-	77	-	nC
Q_{gs}	Gate Source Charge		-	14	-	nC
Q_{gd}	Gate Drain("Miller") Charge		-	14	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On DelayTime	V_{GS} = 10V, V_{DD} = 30V, I_D= 30A, R_{GEN} = 3Ω	-	10	-	ns
t_r	Turn-On Rise Time		-	27	-	ns
$t_{d(off)}$	Turn-Off DelayTime		-	61	-	ns
t_f	Turn-Off Fall Time		-	16	-	ns
Body Diode Characteristics						
I_S	Maximum Continuous Body Diode Forward Current		-	-	60	A
I_{SM}	Maximum Pulsed Body Diode Forward Current		-	-	240	A
V_{SD}	Body Diode Forward Voltage	V_{GS} = 0V, I_S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I_F = 30A, di/dt = 100A/us	-	25	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	28.7	-	nC

Notes:

1.Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.EAS condition: Starting T_J=25℃, V_{DD}=30V, V_G=10V, R_G=25Ω, L=0.5mH, I_{AS}=22.26A, V_{DD}=0V during time in avalanche.

3.RθJA is measured with the device mounted on a 1 $inch^2$ pad of 2oz copper FR4 PCB.

4.Pulse Test: Pulse Width≤300us, Duty Cycle≤0.5%

Test Circuit

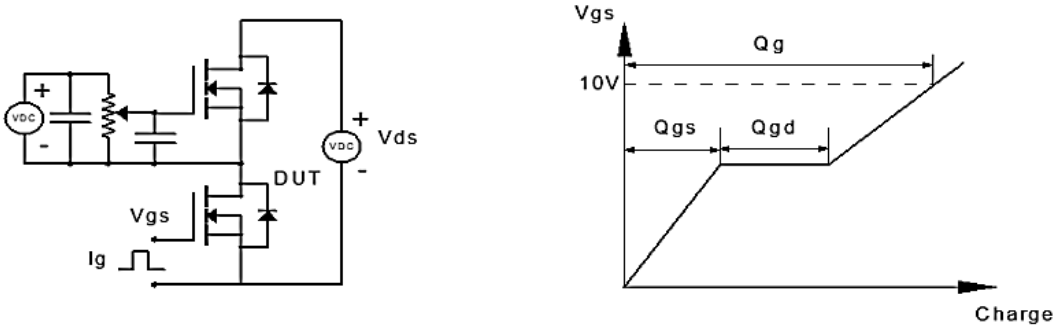


Figure 1: Gate Charge Test Circuit & Waveform

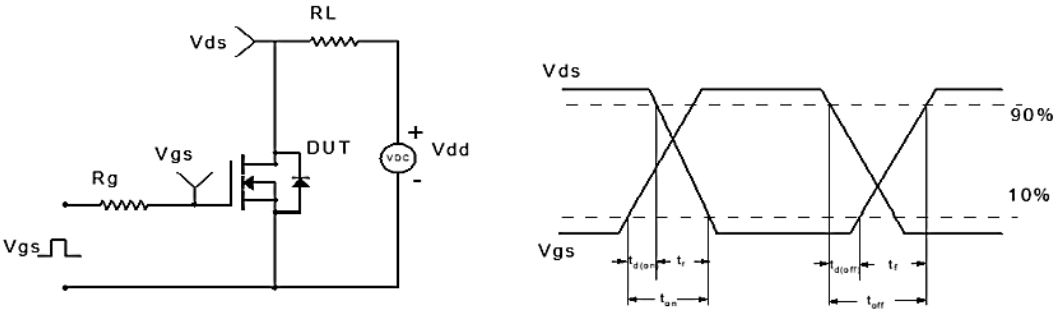


Figure 2: Resistive Switching Test Circuit & Waveform

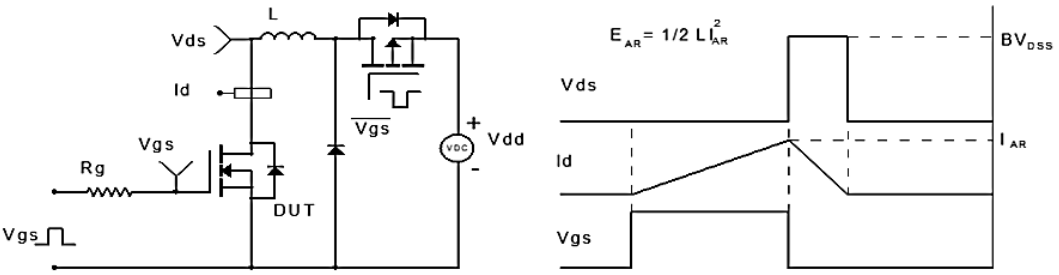


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

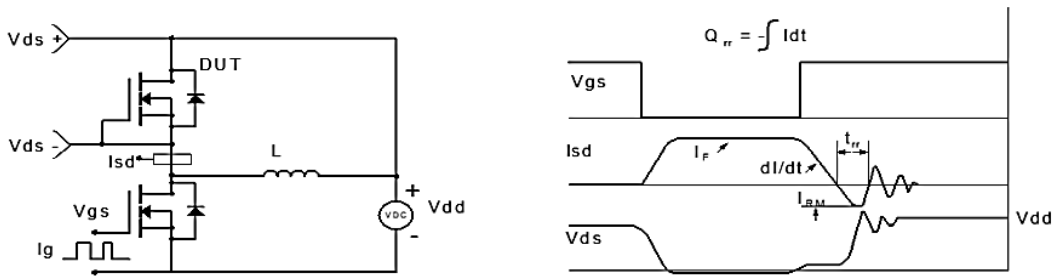
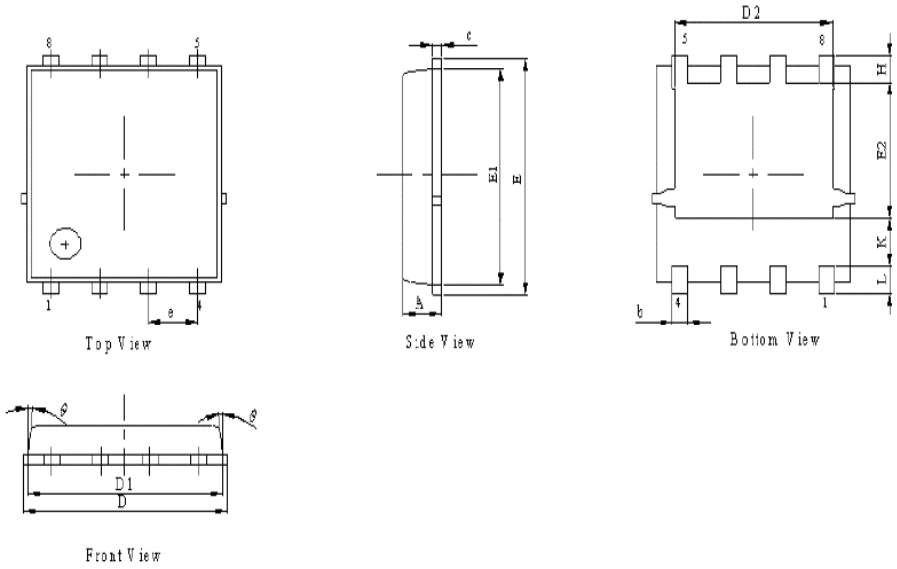
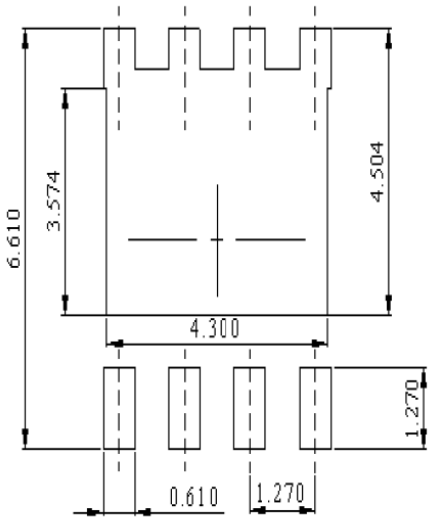


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(PDFN 5x6-8L)



Symbol	Dimensions In Millimeters		
	Min.	NOM.	Max.
A	0.9	1	1.15
b	0.31	0.41	0.51
C	0.24	0.32	0.4
D	5	5.2	5.4
D1	4.95	5.05	5.15
D2	4	4.1	4.2
E	6.05	6.15	6.25
E1	5.5	5.6	5.7
E2	3.42	3.53	3.63
e		1.27 BSC	
H	0.6	0.7	0.8
L	0.5	0.7	0.8
K		1.23 BEF	
O			10



DIMENSIONS:MILLIMETERS

Ordering information

Order Code	Package	V_{DS}(V)	I_D(A)	$R_{DS(ON)}$(mΩ)	
QNN80N06AJ	PDFN 5x6-8	60	60	V_{GS}=10V	8.4
				V_{GS}=4.5V	10.2